# Application Report

# DS2X0DF810 Junction Temperature Readback and Temperature Lock Range (TLR) Extension Procedures



## **ABSTRACT**

A key parameter when using the DS2X0DF810 25-28G retimers is the temperature lock range (TLR) of the device. The TLR refers to the CDR stay-in-lock ambient temperature range that can be supported without any loss-of-lock event. For debug and link monitoring, it may be beneficial to read back the internal junction temperature from the on-die temperature sensor. In particularly challenging operating environments where the ambient temperature varies beyond the default TLR range mentioned in the DS2X0DF810 data sheet, the TLR may be extended to approximately 150°C by applying changes to the CDR loop filter control voltage based on the junction temperature readback. This application note addresses how to configure the DS2X0DF810 retimer to read back junction temperature and extend the TLR through I2C programming.

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Introduction www.ti.com

## 1 Introduction

A key parameter when using the DS2X0DF810 25-28G retimers is the temperature lock range (TLR) of the device. The TLR refers to the CDR stay-in-lock ambient temperature range that can be supported without any loss-of-lock event. In the data sheet, TLR is specified in the *Electrical Characteristics* in terms of both TEMP<sub>LOCK</sub>- (maximum temperature change when ramping down below the initial CDR lock acquisition ambient temperature) and TEMP<sub>LOCK</sub>+ (maximum temperature change when ramping up above the initial CDR lock acquisition ambient temperature).

The DS2X0DF810 25-28G retimers offer a method through I2C programming to extend the TLR to approximately 150°C (typical) in applications where the device junction temperature may vary beyond the default TLR range mentioned in the DS2X0DF810 data sheet. This is made possible by reading back the internal junction temperature through an on-die temperature sensor and then configuring the CDR loop filter control voltage accordingly. This method allows for the maximum change in the loop filter control voltage to tolerate all supported temperature scenarios, including worst-case scenarios when the device locks at extreme temperatures such as –40°C ambient or 110°C junction temperature.

This application note addresses the I2C programming procedure regarding how to read back the junction temperature and how to extend the device TLR based on the junction temperature readback.



# 2 Reading Junction Temperature Procedure

Table 2-1 provides a programming procedure to read the junction temperature from the DS2X0DF810 25-28G retimers. This procedure is beneficial for occasional debug and link monitoring.

## Note

The accuracy of the on-die temperature sensor is not ensured by production testing. Through empirical observation, the temperature sensor readback exhibits a typical T<sub>J</sub> accuracy of approximately ±7°C. Therefore, the procedure should be restricted to occasional debug use only.

**Table 2-1. Programming Procedure for Reading Junction Temperature** 

			~g. a	y	0 101 1104	anig sunction remperature				
STEP	REGISTER SET	OPERATION	REGISTER ADDRESS [HEX]	REGISTER VALUE [HEX]	WRITE MASK [HEX]	COMMENT				
Normal R	Normal Retimer configuration									
	Perform all steps to configure the Retimer as normal. Junction temperature measurements are the most useful when the device is operating in a configuration which mimics the mission-mode configuration.									
Configure	Retimer for t	emperature rea	adback							
1	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
2	Shared	Write	04	40	40	Reset Channel 0 – Channel 3 shared registers				
3	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers				
4	Shared	Write	04	40	40	Reset Channel 4 – Channel 7 shared registers				
5	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
6	Shared	Write	0F	00	FF	Enable temperature detection CH0-CH3				
7	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers				
8	Shared	Write	0F	00	FF	Enable temperature detection CH4-CH7				
9	Shared	Write	FF	01	FF	Disable broadcast write to all channels, read from channel selected in Shared Reg_0xFC				
10	Shared	Write	FC	04	0F	Select single channel				
11	Channel	Write	19	01	C1	Enable channel temperature detection				
12	Channel	Write	18	01	03	Enable channel temperature detection				
13	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
14	Shared	Write	0C	00	38	Configure the input to the analog-to-digital converter (ADC)				
15	Shared	Write	0C	02	03	Enable ADC				
16	Shared	Write	0C	04	04	Reset ADC				
17	Shared	Write	0C	00	04	Set ADC to capture Analog Voltage				
18	Wait 200 µs									
19	Shared	Write	0C	00	02	Disable ADC to freeze value				
Temperati	ure readback									
20	Shared	Read	0D			D <sub>SAR</sub> [7:0] = Reg_0x0E[7:0]				
21	Shared	Read	0E			D <sub>SAR</sub> [9:8] = Reg_0x0E[1:0]				
• Decim	al_representa	ation_of_tempe	erature_code	= (Reg_0x0E	and 0x03) × 2	256 + Reg_0x0D				
		l_representation			_					
Note:	The numbers :	256 and 340 in t	the previous e	quations are <i>d</i>	ecimal numbe	ers.				
22	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
23	Shared	Write	04	40	40	Reset Channel 0 – Channel 3 shared registers				
24	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers				
25	Shared	Write	04	40	40	Reset Channel 4 – Channel 7 shared registers				
26	Shared	Write	FF	01	FF	Enable read/write from/to channel selected in Reg_0xFC				
27	Shared	Write	FC	04	0F	Select single channel				



Table 2-1. Programming Procedure for Reading Junction Temperature (continued)

STEP	REGISTER SET	OPERATION	REGISTER ADDRESS [HEX]	REGISTER VALUE [HEX]	WRITE MASK [HEX]	COMMENT
28	Channel	Write	19	00	C1	Disable channel temperature detection
29	Channel	Write	18	00	03	Disable channel temperature detection

## 3 Extending Temperature Lock Range (TLR) Procedure

The DS2X0DF810 retimer TLR can be extended to support CDR stay-in-lock between -40°C ambient temperature to 110°C junction temperature. This is accomplished by expanding on the internal junction temperature readback procedure shown in Section 2.

To extend TLR based on the internal junction temperature readback, the complete programming procedure in Table 3-1 should be included as part of the normal retimer programming procedure. For simplicity, this procedure is written assuming all channels in the retimer are being configured at the same time. Refer to the *Common Device Configurations* section of the DS2X0DF810 Programming Guide for example programming procedures.

#### Note

Insert this procedure just prior to the step where the CDR reset is asserted and de-asserted.

Table 3-1. Programming Procedure for Each Channel to Achieve Extended TLR

	Tubic		REGISTER	REGISTER	WRITE	anner to Achieve Extended 1 LR				
STEP	REGISTER	OPERATION	ADDRESS	VALUE	MASK	COMMENT				
	SET		[HEX]	[HEX]	[HEX]					
Normal R	Normal Retimer configuration									
	Perform all steps to configure the Retimer as normal, except for the final step, which is to assert and de-assert the CDR reset. This step will be performed at the conclusion of this Extended TLR programming procedure.									
Configure	Retimer for t	emperature rea	adback							
1	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
2	Shared	Write	04	40	40	Reset Channel 0 – Channel 3 shared registers				
3	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers				
4	Shared	Write	04	40	40	Reset Channel 4 – Channel 7 shared registers				
5	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
6	Shared	Write	0F	00	FF	Enable temperature detection CH0-CH3				
7	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers				
8	Shared	Write	0F	00	FF	Enable temperature detection CH4-CH7				
9	Shared	Write	FF	03	FF	Enable broadcast write to all channels, read from channel selected in Shared Reg_0xFC				
10	Shared	Write	FC	04	0F	Select single channel				
11	Channel	Write	0A	00	0C	Release CDR from reset				
12	Channel	Write	14	80	80	Force-enable signal detect to ensure all channels are powered on prior to reading device temperature				
13	Channel	Write	19	01	C1	Enable channel temperature detection				
14	Channel	Write	18	01	03	Enable channel temperature detection				
15	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers				
16	Shared	Write	0C	00	38	Configure the input to the analog-to-digital converter (ADC)				
17	Shared	Write	0C	02	03	Enable ADC				
18	Shared	Write	0C	04	04	Reset ADC				
19	Shared	Write	0C	00	04	Set ADC to capture Analog Voltage				
20	Wait 200 µs									
21	Shared	Write	0C	00	02	Disable ADC to freeze value				



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Table 3-1. Programming Procedure for Each Channel to Achieve Extended TLR (continued)

STEP	REGISTER SET	OPERATION	REGISTER ADDRESS [HEX]	REGISTER VALUE [HEX]	WRITE MASK [HEX]	COMMENT		
Temperatu	Temperature readback and Loop Filter Voltage calculation							
22	Shared	Read	0D			D <sub>SAR</sub> [7:0] = Reg_0x0E[7:0]		
23	Shared	Read	0E			D <sub>SAR</sub> [9:8] = Reg_0x0E[1:0]		

- Decimal\_representation\_of\_temperature\_code = (Reg\_0x0E and 0x03) × 256 + Reg\_0x0D
- LPF\_Setting = 0.44 × Decimal\_representation\_of\_temperature\_code 55
  - If (LPF\_Setting < 120), then LPF\_Setting = 120
  - If (LPF Setting > 210), then LPF Setting = 210
- Note: The numbers 256, 55, 120, and 210 in the previous equations are decimal numbers.

Configur	e Loop Filter V	/oltage				
24	Shared	Write	FF	03	03	Enable broadcast write to all channels, read from channel selected in Shared Reg_0xFC
25	Channel	Write	9D	LPF_ Setting	FF	Configures the Loop Filter Voltage based on the results of the previous equation
26	Channel	Write	17	25	FF	Enable extended temperature lock range
De-activa	ate device tem	perature sensi	ng			
27	Shared	Write	FF	10	FF	Select Channel 0 – Channel 3 shared registers
28	Shared	Write	04	40	40	Reset Channel 0 – Channel 3 shared registers
29	Shared	Write	FF	20	FF	Select Channel 4 – Channel 7 shared registers
30	Shared	Write	04	40	40	Reset Channel 4 – Channel 7 shared registers
31	Shared	Write	FF	03	FF	Enable writing to all channels
32	Channel	Write	19	00	C1	Disable channel temperature detection
33	Channel	Write	18	00	03	Disable channel temperature detection
34	Channel	Write	14	00	80	Undo force-enable of signal detect
Conclude	normal Retin	ner configurati	on		•	
35	Channel	Write	0A	0C	0C	Assert CDR reset
36	Channel	Write	0A	00	0C	De-assert CDR reset
37	Shared	Write	FF	01	01	Disable Broadcast write operation

## 4 Summary

This application note addresses how to program the DS2X0DF810 25-28G retimers to read the internal junction temperature from the on-die temperature sensor and how to extend the TLR based on the junction temperature readback. By applying these procedures, designers have a method to monitor the approximate junction temperature of the DS2X0DF810 retimer. Moreover, the robustness of the DS2X0DF810 may be further increased in challenging operating environments where the ambient temperature varies beyond the default TLR range mentioned in the DS2X0DF810 data sheet.

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